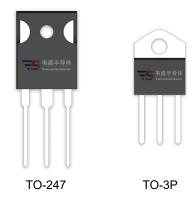


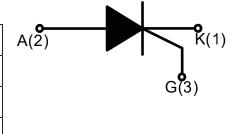
### **DESCRIPTION:**

With high ability to withstand the shock loading of large current, BT155K-1200T series of silicon controlled rectifiers provide high dv/dt rate with strong resistance to electromagnetic interference. They are especially recommended for use on solid state relay, motorcycle, power charger, T-tools etc.



### **MAIN FEATURES**

Symbol	Value	Unit
I <sub>T(RMS)</sub>	75	Α
V <sub>DRM</sub> /V <sub>RRM</sub>	1200	V
I <sub>GT</sub>	≤70	mA



### **ABSOLUTE MAXIMUM RATINGS**

Parameter		Symbol	Value	Unit
Storage junction temperature range		T <sub>stg</sub>	-40-150	$^{\circ}$ C
Operating junction temperature range		Tj	-40-125	$^{\circ}$
Repetitive peak off-state voltage(T <sub>j</sub> =25℃)		V <sub>DRM</sub>	1200	V
Repetitive peak reverse voltage(T <sub>j</sub> =25℃)		V <sub>RRM</sub>	1200	V
Non repetitive surge peak Off-state voltage		V <sub>DSM</sub>	V <sub>DRM</sub> +100	V
Non repetitive peak reverse voltage		V <sub>RSM</sub>	V <sub>RRM</sub> +100	V
RMS on-state current	TO-247S/ TO-247/ ITO-247(Ins) (Tc=70°C) TO-3P(Ins) (Tc=60°C)	I <sub>T(RMS)</sub>	75	А



Non repetitive surge peak on-state current (tp=10ms)	I <sub>TSM</sub>	800	А
I <sup>2</sup> t value for fusing (tp=10ms)	l²t	3200	A <sup>2</sup> s
Critical rate of rise of on-state current $(I_G=2\times I_{GT})$	dl/dt	150	A/µs
Peak gate current	I <sub>GM</sub>	4	Α
Average gate power dissipation	P <sub>G(AV)</sub>	1	W
Peak gate power	P <sub>GM</sub>	5	W

# **ELECTRICAL CHARACTERISTICS** (T<sub>j</sub>=25°C unless otherwise specified)

Symbol	Toot Condition	Value			I I to i 4
	Test Condition	MIN.	TYP.	MAX.	Unit
I <sub>GT</sub>	$V_D$ =12V R <sub>L</sub> =33 $\Omega$	-	-	70	mA
V <sub>GT</sub>		-	-	1.3	V
V <sub>GD</sub>	$V_D=V_{DRM}T_j=125^{\circ}C$ RL=3.3K $\Omega$	0.2	-	-	V
IL	I <sub>G</sub> =1.2I <sub>GT</sub>	-	-	150	mA
lн	I <sub>T</sub> =1Α	-	-	120	mA
dV/dt	V <sub>D</sub> =2/3V <sub>DRM</sub> Gate Open T <sub>j</sub> =125℃	700	-	-	V/µs

# **STATIC CHARACTERISTICS**

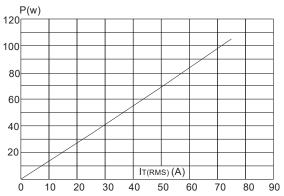
Symbol	Parameter		Value(MAX)	Unit
V <sub>TM</sub>	I <sub>TM</sub> =100A tp=380μs	Tj=25℃	1.5	V
IDRM	VD=VDRM VR=VRRM	Tj=25℃	50	μA
I <sub>RRM</sub>		Tj=125℃	10	mA

## **THERMAL RESISTANCES**

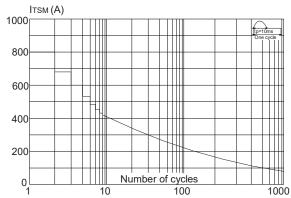
Symbol	Parameter		Value	Unit
R <sub>th(j-c)</sub>	junction to case(AC)	TO-247J/ ITO-247(Ins)	0.53	
		TO-3P(Ins)	0.60	°C/W
		TO-247S	0.52	



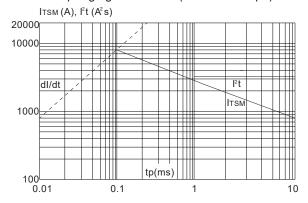
**FIG.1:** Maximum power dissipation versus RMS on-state current



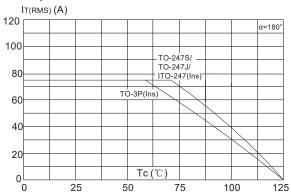
**FIG.3:** Surge peak on-state current versus number of cycles



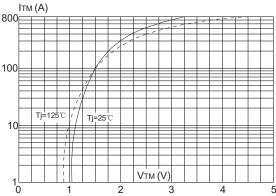
**FIG.5:** Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<10ms, and corresponging value of I<sup>2</sup>t (dI/dt < 150A/µs)



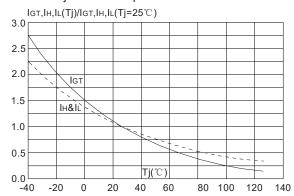
**FIG.2:** RMS on-state current versus case temperature



**FIG.4:** On-state characteristics (maximum values)



**FIG.6:** Relative variations of gate trigger current, holding current and latching current versus junction temperature







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